SH-1: SH7032/SH7034 Product Brief

SH7000 Series 32-Bit RISC Embedded Controller

HITACHI

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Overview

The SH7000 series is a reduced instruction set computer (RISC) in which a Hitachi-original CPU and the peripheral functions required for system configuration are integrated onto a single chip.

The CPU has a RISC-type instruction set. Most instructions can be executed in one clock cycle, dramatically improving instruction execution speed. In addition, the CPU has a 32-bit internal architecture for enhanced data-processing ability. As a result, the SH7032/SH7034 enable high-performance systems to be constructed with advanced functionality at low cost, even in applications such as real-time control that require operations at very high speeds.

The SH microcomputer includes peripheral functions such as large-capacity ROM, RAM, a direct memory access controller (DMAC), timers, a serial communication interface (SCI), an A/D converter, an interrupt controller (INTC), and I/O ports. External memory access support functions enable direct interface to PSRAM and DRAM. These features can drastically reduce system cost.

For on-chip ROM, masked ROM or electrically programmable ROM (PROM) can be selected. The PROM version can be programmed by users with a general-purpose EPROM programmer.

Features

- 20 MHz at 5 V, 12.5 MHz at 3.3 V
- SH7032: ROMless, 8-kbyte RAM
- SH7034: 64-kbyte ROM/EPROM, 4-kbyte RAM
- SuperHTM RISC engine (CPU)
 - 32-bit internal data paths/32-bit external data paths
 - 16-bit fixed instruction set
 - Five-stage pipeline
 - Load/store register architecture
 - Sixteen 32-bit general registers, three 32-bit control registers, and four 32-bit system registers
- On-chip multiply and accumulate unit
 - Multiplication operations ($32 \times 32 \rightarrow 64$ bits) executed in 2 to 3 cycles
 - MAC operations ($32 \times 32 \rightarrow 64 + 64$ bits) executed in 2 to 3 cycles
- Processing states:
 - Power-on reset/manual reset
 - Exception processing

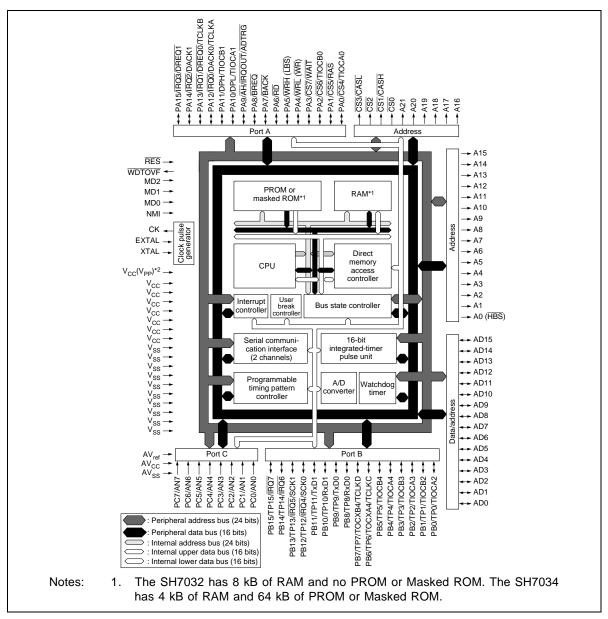
- Program execution
- Power-down (sleep, standby, and module stop modes)
- Bus-released
- Bus State Controller (BSC)
 - Supports interface to PSRAM, DRAM, ROM, and peripheral I/O
 - DRAM refresh and burst access functions
 - One-stage write buffer for improved system performance
 - 16/8-bit bus width for addressing options
 - Number of wait states variable
- Four-channel Direct Memory Access Controller (DMAC)
 - DMA transfers between on-chip or external memory, I/O, and peripheral modules
 - Selectable priorities and modes
 - Dual or single address transfer mode, external request resources mode, and dual address transfer mode for internal request sources supported
- Interrupt Controller (INTC)
 - Nine external interrupt pins
 - Thirty-one internal interrupt sources
 - Sixteen programmable priority levels
- Five-channel 16-bit Integrated Timer Unit (ITU)
 - Ten waveforms can be output
 - PWM modes
 - Counters, input capture/measurement
- Watchdog Timer (WDT)
- Programmable Timing Pattern Controller with maximum 16-bit output (4 bits × 4 channels)
- 10-bit/8-channel A/D Converter with variable voltage reference and external triggering capability
- Two-channel SCI with full duplex and asynchronous/synchronous selectable modes
- 32 I/O, plus 8 input only ports
- User Break Controller (UBC) for generating interrupts to simplify debugging
- Operating temperature: -20°C to 75°C
- Package: 112-pin Quad Flat Pack (QFP)
- Process: 0.8-micron technology
- Complete development systems support

Related Manuals

- SH Series Overview
- SH7032/7034 Hardware Manual
- SH7000/7600 Programming Manual

See also http://www.halsp.hitachi.com.

Block Diagram



Block Diagram (SH7032/7034)

Instruction Set By Classification (Total: 56 Types)

Table 1 Data Transfer (5 Types)

Operation Code	Function
MOV	Data transfer, immediate data transfer, peripheral module, and structural data transfers
MOVA	Effective address transfer
MOVT	T-bit transfer
SWAP	Swap of upper and lower bytes
XTRCT	Extraction of middle of connected registers

Table 2 Arithmetic Operations (17 Types)

Function
Binary addition
Binary addition with carry
Binary addition with overflow check
Comparison
Division
Initialization of signed division
Initialization of unsigned division
Sign extension
Zero extension
Multiplication and accumulation
Signed multiplication
Unsigned multiplication
Negation
Negation with carry
Binary subtraction
Binary subtraction with carry
Binary subtraction with underflow check

Table 3 Logic Operations (6 Types)

Operation Code	Function
AND	Logic AND
NOT	Bit inversion
OR	Logical OR
TAS	Memory test and bit set
TST	Logical AND and T bit set
XOR	Exclusive OR

Table 4 Shift Instructions (10 Types)

Function
One-bit left rotation
One-bit right rotation
One-bit left rotation with T bit
One-bit right rotation with T bit
One-bit arithmetic left shift
One-bit arithmetic right shift
One-bit logical left shift
n-bit logical left shift
One-bit logical right shift
n-bit logical right shift

Table 5 Branch Instructions (7 Types)

Operation Code	Function
BF	Conditional branch (T = 0)
BT	Conditional branch (T = 1)
BRA	Unconditional branch
BSR	Branch to subroutine procedure
JMP	Unconditional branch
JSR	Branch to subroutine procedure
RTS	Return from subroutine procedure

Table 6 System Control (11 Types)

Operation Code	Function
CLRT	T bit clear
CLRMAC	MAC register clear
LDC	Load to control register
LDS	Load to system register
NOP	No operation
RTE	Return from exception processing
SETT	T bit set
SLEEP	Shift into power-down mode
STC	Storing control register data
STS	Storing system register data
TRAPA	Trap exception processing

DC Characteristics

Table 7 Current Consumption*³

Item	Symbol	Min	Тур	Max Unit		Measurement Conditions			
Ordinary operation	I _{cc}	_	60	90	mA	f = 12.5 MHz			
Ordinary operation	I _{cc}	_	80	110	mA	f = 16.6 MHz			
Sleep	I _{cc}	_	40	70	mA	f = 12.5 MHz			
Sleep	I _{cc}	_	50	80	mA	f = 16.6 MHz			
Standby	I _{cc}	_	0.01	5* ¹	μΑ	Ta ≤ 50°C			
Standby	I _{cc}	_	_	20.0*2	μΑ	50°C < Ta			

Notes: 1. $50 \mu A$ for the SH7032.

- 2. $300 \,\mu\text{A}$ for the SH7032.
- 3 Conditions: V_{cc} = 5.0 V ±10%, A V_{cc} = 5.0 V ±10%, A V_{cc} = V_{cc} ±10%, AVref = 4.5 V to A V_{cc} , V_{ss} = AV_{ss} = 0 V, f = 20 MHz, Ta = -20 to +75°C for normal products, Ta = -40 to +85°C for wide-temperature range products.

AC Characteristics

Table 8 LSI Clock Frequency

		Case A		Case B					
		12.5 MHz		16.6 MHz 20		MHz	-		
Item	Symbol	Min	Max	Min	Max	Min	Max	Unit	Figures
EXTAL input high level pulse width	t _{EXH}	20	_	10	_	10	_	ns	1
EXTAL input low level pulse width	$t_{\sf EXL}$	20	_	10	_	10	_	ns	1
EXTAL input rise time	t _{EXr}	_	10	_	5	_	5	ns	1
EXTAL input fall time	t _{EXf}	_	10		5	_	5	ns	1
Clock cycle time	t _{cyc}	80	500	60	500	50	500	ns	1, 2
Clock high pulse width	t _{ch}	30		20	_	20		ns	2
Clock low pulse width	t _{CL}	30		20	_	20		ns	2
Clock rise time	t _{Cr}	_	10		5	_	5	ns	2
Clock fall time	t _{Cf}	_	10	_	5	_	5	ns	2
Reset oscillation settling time	t _{osc1}	10		10	_	10		ms	3
Software standby oscillation settling time	t _{oSC2}	10	_	10	_	10	_	ms	3

- Notes: 1. Case A: $V_{cc} = 3.0$ to 5.5 V, $AV_{cc} = 3.0$ to 5.5 V, $AV_{cc} = V_{cc} \pm 10\%$, AVref = 3.0 V to AV_{cc} , $V_{ss} = AV_{ss} = 0$ V, f = 20 MHz, Ta = -20 to $+75^{\circ}C$
 - 2. Case B: V_{cc} = 5.0 V ±10%, AV $_{cc}$ = 5.0 V ±10%, AV $_{cc}$ = V_{cc} ±10%, AV ref = 4.5 V to AV $_{cc}$, V $_{ss}$ = AV $_{ss}$ = 0 V, f = 20 MHz, Ta = -20 to +75°C for normal products; Ta = -40 to +85°C for wide-temperature range products.

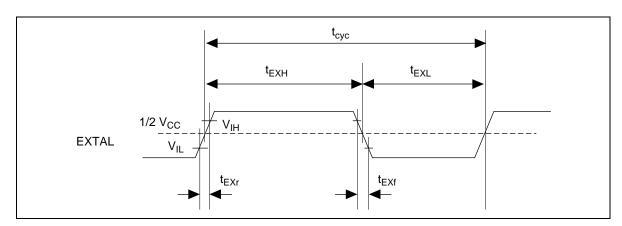


Figure 1 EXTAL Input Timing

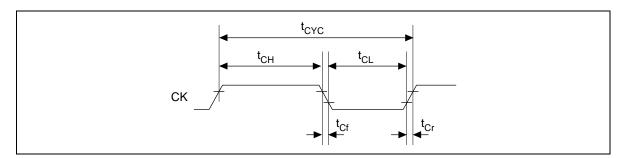


Figure 2 System Clock Timing

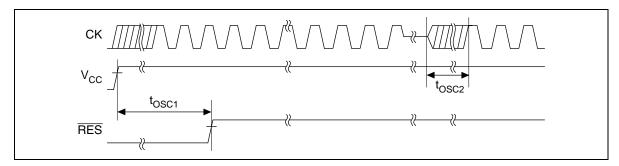
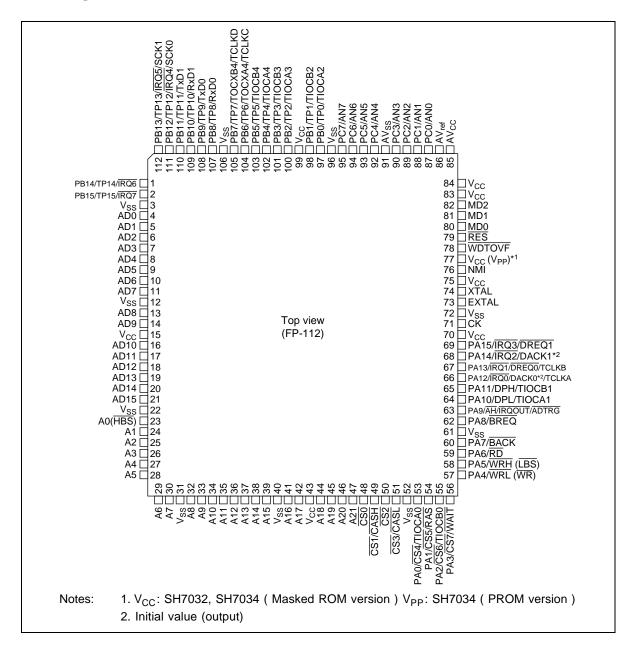
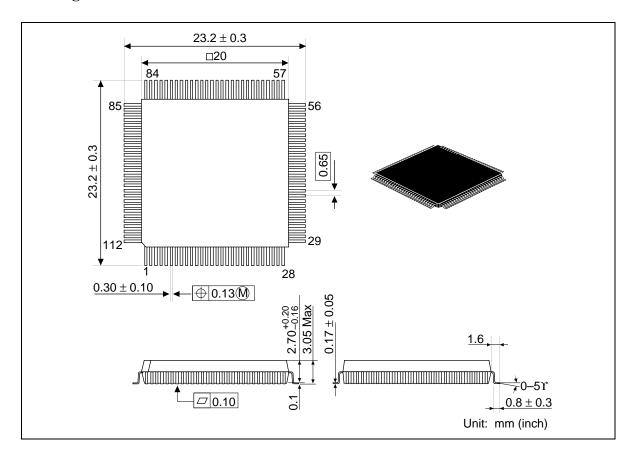


Figure 3 Oscillation Settling Time

Pin Diagram



Package Dimensions



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